



# Product Change Notification

**Change Notification #:** 116728 - 00  
**Change Title:** Intel® Server System R1208SPOSHORR, PCN 116728-00, Product Design, Update PSoC Chip Firmware for Hot Swap Back Plane  
**Date of Publication:** January 22, 2019

## Key Characteristics of the Change:

Product Design

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:*</b>	February 8, 2019
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\* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

## Description of Change to the Customer:

Intel is implementing the following changes on the Intel® Server System R1208SPOSHORR:

- Update the old PSoC Chip Firmware version with the new PSoC Chip 1.41 Firmware version for the Hot Swap Back Plane.

All new components are identical in form factor and function to the replaced ones.

## Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications.

## Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
R1208SPOSHORR	951874	J49136-008	J49136-009

## PCN Revision History:

<b>Date of Revision:</b> January 22, 2019	<b>Revision Number:</b> 00	<b>Reason:</b> Originally Published PCN
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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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